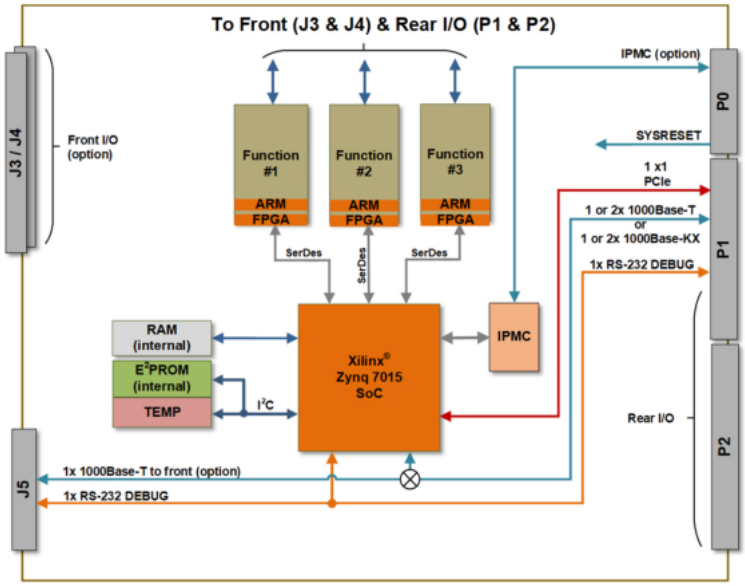
68G5 3U OpenVPX Multifunction I/O Boards

3U OpenVPX Multifunction I/O Board

The 68G5 is NAI's latest rugged 3U OpenVPX multifunction I/O and communications board. It provides high-performance I/O capabilities specifically designed for demanding aerospace, defense, and industrial applications. The board can accommodate up to three NAI Configurable Open Systems Architecture™ (COSA®) smart function modules. By configuring the 68G5 with these modules, engineers can tailor the board's functionality for specific application needs, accelerating the deployment of SWaP-C optimized systems.



Features

- **3U OpenVPX**
- **Profiles Supported:**
  - Module profile: MOD3-PER-1U-16.3.3-2
  - Slot profile: SLT3-PER-1U-14.3.3
- **Front and/or rear I/O**
- **PCIe (x1)**
- **Supports Three NAI smart I/O function modules**
  - COSA® architecture
  - 100+ modules to choose from
  - Independent x1 SerDes interface to each function module slot
- **2x 10/100/1000 Base-T or 1000Base-KX Ethernet; 2 to rear or 1 to rear and 1 to front I/O**
- **Intelligent I/O library support included**
- **Background Built-in-Test Continuous (BIT)**
- **VICTORY Interface Services (Contact factory)**
- **Operating Temperature**
  - Commercial: 0°C to 70°C
  - Rugged: -40°C to 85°C

Select up to 3 independent functions for your application

I/O Modules

Function	Module	Description
Analog-to-Digital	AD1	12 CH. A/D, ±10 V, Dedicated, 256 kHz (max), Sigma-Delta
	AD2	12 CH. A/D, ±100 V (max), Dedicated, 256 kHz (max), Sigma-Delta
	AD3	12 CH. A/D, ±25 mA, Dedicated, 256 kHz (max), Sigma-Delta
	AD4	16 CH. A/D, ± 10 V, Multiplexed, 500 KHz Agg / 8 Ch, SAR
	AD5	16 CH. A/D, ± 50 V, Multiplexed, 500 KHz Agg / 8 Ch, SAR
	AD6	16 CH. A/D, ± 100 V, Multiplexed, 500 KHz Agg / 8 Ch, SAR
	ADE	16 CH. A/D, ±10 V, Individual 16-bit SAR, 200 kHz max., Simultaneous Sampling
	ADF	16 CH. A/D, ±100 V, Individual 16-bit SAR, 200 kHz max., Simultaneous Sampling
Chip Detector and Fuzz Burn	CD1	6 CH. Chip Detector (CD) and Fuzz Burn (FB)
Digital-to-Analog	DA1	12 CH. D/A, ± 10 V, 25 mA Per Channel, Current or Voltage Control
	DA2	16 CH. D/A, ± 10 V, 10 mA Per Channel, No Current Control
	DA3	4 CH. D/A, ±40 V, ±100 mA, Voltage or Current Output
	DA4	4 CH. D/A, ± 20 to ± 80, 10 mA, Voltage Control Only

Function	Module	Description
Digital-to-Analog	DA5	4 CH. D/A, High-Voltage/High-Current Half-Bridge (2 Channels Full-Bridge) External VCC Sourced Outputs
Digital IO - Differential Transceiver	DF1	16 CH. Differential I/O, Input: -10 V to +10 V (422), -7 V to +12 V (485) Output: -.25 V to +5 V
	DF2	16 CH. 16 Channel Enhanced Differential I/O
Discrete IO - Multichannel,Programmable	DT1	24 CH. Discrete I/O, 0-60 VDC Input/Output, Max Iout 500 mA - 2 A, Source/Sink (out)
	DT2	16 CH. Discrete I/O, ±80 V Input/Output, Max Iout 600 mA, Isolated/Ch Switch (out)
	DT3	4 CH. Discrete Hi & Lo Side Switch Output @ 65V/2A (max), external individual supplied VCC & VSS per channel pair
	DT4	24 CH. Enhanced DT1
	DT5	16 CH. Enhanced DT2
Relay	RY1	4 CH. Relay, 220V/2A @ 60W/62.5VA (Max), Non Latching
	RY2	4 CH. Relay, 220V/2A @ 60W/62.5VA (Max), Latching
Digital IO - TTL,CMOS	TL1	24 CH. TTL I/O, Standard Functionality, Programmable
	TL2	24 CH. TTL I/O, Enhanced Functionality, Programmable
Variable Reluctance	VR1	8 CH. Variable Reluctance Signal Input and General-Purpose Pulse Counter, ±100 V, 100 kHz (max)

Measurement & Simulation Modules

Function	Module	Description
AC Reference	AC2	2 CH. AC Reference Source, 47 Hz - 20 KHz, ± 3% Acc, 2 – 28 Vrms, 6 VA (Max/Ch) Power
	AC3	2 CH. AC Reference Source, 47 Hz - 2.5 KHz, ± 3% Acc, 28 – 115 Vrms, 6 VA (Max/Ch) Power
LVDT RVDT Measurement and Simulation	DLx	1 - 3 CH. Digital to LVDT/RVDT, 2 - 90 Vrms Full Scale, 2 - 115 Vrms Exc, 47 Hz - 20 kHz Freq
	LD1	4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 47 Hz -1 KHz Freq
	LD2	4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 1 KHz - 5 KHz Freq
	LD3	4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 5 KHz - 10 KHz Freq
	LD4	4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 10 KHz - 20 KHz Freq
	LD5	4 CH. LVDT/RVDT to Digital, 28-90 Vrms Input, 2-115 Vrms Exc, 47 Hz - 1 KHz Freq

Function	Module	Description
Synchro Resolver Measurement and Simulation	DSx (DRx)	1 - 3 CH. Digital to Synchro/Resolver, 2 - 90 VLL, 2 - 1115 Vrms Exc, 47 Hz - 20 kHz Freq
	SDx	4 CH. Synchro/Resolver to Digital, 2 - 90 Vrms Input, 2 - 115 Vrms Exc, 47 Hz to 20 kHz Freq
Pulse Timer Receiver and Generator	PT1	2 CH. Pulse Timer 1-PPS &/or 10 MHz Input with Multiple Outputs and 2 Channels Isolated RS-422/485 Serial Communications
IRIG Timecode Receiver and Generator	RG1	1 CH. IRIG Timing Function Interface
Thermocouple and RTD Measurement	RT1	8 CH. Resistance Temperature Detectors (RTD), 2, 3, or 4 wire, 16 Bit Res, 16.7 Hz/Ch
	TC1	8 CH. Thermocouple, 4.17 - 470 Hz, ±100 mV A/D
	TR1	8 CH. Thermocouple (TCx) & Resistance Temperature Detectors (RTD), programmable per channel
Strain Gauge Measurement	SG1	4 CH. Strain Gauge, 4.7 Hz - 4.8 KHz, Measurement, Conventional 4-Arm Bridge

Communication Modules					
Function	Module	Description	Function	Module	Description
ARINC Communications	AR1	12 CH. ARINC 429, 100 KHz or 12.5 KHz, RX/TX, 256 Word Tx/Rx Buffer	MIL-STD-1553B	FTE	2 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Direct Coupled
	AR2	1 CH. ARINC 568 (CH-1, RX & TX) & 1 Channel ARINC 579 (CH-2, Programmable RX or TX), 1024-Word TX & RX Buffers per Ch.		FTF	4 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Direct Coupled
CANBus Communications	CB1	8 CH. CANBus, CAN 2.0 A/B, 16 K RX/TX Buffer, 1 Mb/s Max Data Rate	MIL-STD-1760	FTJ	1 CH. MIL-STD-1760 (1553), BC, RT, BM, BM/RT, 128 KB RAM, Transformer Coupled
	CB2	8 CH. CANBus, J1939, 16 K RX/TX Buffer, 500 kb/s Max Data Rate		FTK	2 CH. MIL-STD-1760 (1553), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Transformer Coupled
	CB3	8 CH. CANBus, CAN 2.0 A/B (CB1) or J1939 (CB2) protocol layer programmable per channel	Serial Communications	SC1	4 CH. Serial, RS-232/422/423 (MIL-STD-188C)/485, Non Isolated
MIL-STD-1553B	FTA	1 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM, Transformer Coupled		SC3	8 CH. (max) RS-232/422/485 Serial Communications or GPIO, Programmable, Non-isolated
	FTB	2 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Transformer Coupled		SC5	4 CH. RS-232/422/485 communications, isolated per channel and from SYS GND
	FTC	4 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Transformer Coupled		SC6	4 CH. RS-232/422/485 communications, individual SYS GND provided per channel (non-isolated)
	FTD	1 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM, Direct Coupled			

Combination Modules					
Function	Module	Description	Function	Module	Description
Combo	CM5	2 CH. Dual-redundant MIL-STD-1553 & 8 Channel ARINC 429/575, 100 KHz or 12.5 KHz, RX or TX, 256 Word Tx/Rx Buffer	Combo	CM8	2 CH. Dual-redundant MIL-STD-1553 & 12 Channel Discrete I/O, 0-60 VDC Input/Output, Max Iout 500 mA - 2 A, Source/Sink (out)

Architected for Versatility

NAI's Configurable Open Systems Architecture™ (COSA®) offers a choice of over 100 smart I/O, communications, or Ethernet switch functions, providing the highest packaging density and greatest flexibility of ruggedized embedded product solutions in the industry. Preexisting, fully-tested functions can be combined in an unlimited number of ways quickly and easily.

One-Source Efficiencies

Eliminate man-months of integration with a configured, field-proven system from NAI. Specification to deployment is a seamless experience as all design, state-of-the-art manufacturing, assembly and test are performed - by one trusted source. All facilities are located within the U.S. and optimized for high-mix/low volume production runs and extended lifecycle support.

Product Lifecycle Management

From design to production and beyond, NAI's product lifecycle management strategy ensures the long-term availability of COTS products through configuration management, technology refresh and obsolescence component purchase and storage.